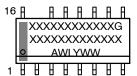


**DATE 28 JAN 2011** 

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION 6 DOES NOT INCLUDE DAMBAR
  PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD **PROTRUSIONS**
- 5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

	MILLIMETERS		
DIM	MIN	MAX	
Α	1.35	1.75	
A1	0.10	0.25	
b	0.35	0.49	
C	0.19	0.25	
D	9.80	10.00	
Е	3.80	4.00	
е	1.27 BSC		
Н	5.80	6.20	
h	0.25	0.50	
L	0.40	1.25	
M	0°	7°	

## **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code

= Assembly Location

WI = Wafer Lot Υ = Year WW = Work Week = Pb-Free Package G

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

## **SOLDERING FOOTPRINT**

15X 1.12	6
0.58	
8 s	PITCH PITCH PITCH PITCH PITCH PITCH

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DESCRIPTION:	SOIC-16 NB, LESS PIN 15		PAGE 1 OF 1

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